

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

	PRODUC	Γ/PRO	CESS	CHANGE NOT	ΓICE (PO	CN)		
PCN #: AI19 Product Affected		DATE:	30-Oct-20	MEANS OF DISTING Product Mark Back Mark Date Code Other	NGUISHING (No change to		D DEVICES:	
Date Effective:	30-Oct-2019							
Contact:	PCN DESK			Attachment:	Yes		No	
E-mail:	idt-pcn@lm.renesas.	<u>com</u>		Samples: N/A				
DESCRIPTION AND PURPOSE OF O ☐ Die Technology ☐ Wafer Fabrication Process ☐ Assembly Process		This notifi	g from 1 to	advise our customers tha 3. Description and Package	t the datasheet	is update	d to correct	
☐ Equipment		ZMOD4410AI1V		4410 Sensor Module, 3.0 × 3.0 × 0.7 mm 12	,	Tray	-40°C to +65°C	
☐ Material		ZMOD4410AI1R	ZMOI	4410 Sensor Module, 3.0 × 3.0 × 0.7 mm 12	-LGA 3	Reel	-40°C to +65°C	
☐ Testing ☐ Manufacturing Site ☐ Data Sheet		ZMOD4410-EVK	(USB	4410 Evaluation Kit including the ZMOD4410 nterface), and Micro-USB Cable. (The ZMOD on www.IDT.com/ZMOD4410-EVK.)				
Other RELIABILITY/ N/A	QUALIFICATION SU			locument/dst/zmod4410-	datasheet			
IDT records indi to grant approval it will be assume IDT reserves the	l or request additional in the data of the	itten notific nformation. eptable. ion manufa	ation of this If IDT does	change. Please use the a not receive acknowledge the process change effect	ement within 3	0 days of	this notice	
Customer:			_	☐ Approval for s	shipments p	rior to e	effective dat	e.
Name/Date:			_	E-Mail Address:				
Title:			_	Phone# /Fax# :				
CUSTOMER CO	OMMENTS:							
IDT ACKNOWI	LEDGMENT OF REC	EIPT:						
RECD. BY:				DATE:				